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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:NEW ASSIGNMENTNATURE OF CONVEYANCE:ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KENGO TAKEMASA	03/28/2013
YUICHI YOSHIDA	04/01/2013
TOSHIHISA SONE	04/01/2013
KAZUYA YAMADA	04/01/2013
AKIHIRO TAKEI	04/01/2013

RECEIVING PARTY DATA

Name:	LAPIS SEMICONDUCTOR CO., LTD.	
Street Address:	2-4-8 SHINYOKOHAMA, KOUHOKU-KU	
City:	YOKOHAMA	
State/Country:	JAPAN	
Postal Code:	222-8575	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14987084

CORRESPONDENCE DATA

Fax Number: (202)408-0924

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-371-8976

Email: firm@rabinberdo.com **Correspondent Name:** RABIN & BERDO, P.C.

Address Line 1: 1101 14TH ST., N.W., SUITE 500 Address Line 4: WASHINGTON, D.C. 20005

ATTORNEY DOCKET NUMBER: TAI-321D1

NAME OF SUBMITTER: STEVEN M. RABIN

SIGNATURE: /Steven M. Rabin/

DATE SIGNED: 01/04/2016

Total Attachments: 2

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PATENT REEL: 037401 FRAME: 0293

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PATENT REEL: 037401 FRAME: 0294

Attorney Reference				
ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT				
WHEREAS Kengo TAKEMASA, Yuichi YOSHIDA, Toshihisa SONE, Kazuya YAMADA and Akihiro TAKEI,				
hereinafter referred to collectively as the assignor, has invented a certain improvement relating to SEMICONDUCTOR DEVICE AND MEASUREMENT DEVICE [X] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office; [] said application having been filed in the United States Patent and Trademark Office on, authorization being hereby given to the practitioners associated with the Customer Number 23995, to insert here in parentheses (Application Serial No. [] said application having been filed under the Patent Cooperation Treaty on Serial No.) [] said application having been filed under the Patent Cooperation Designated.				
AND WHEREAS LAPIS Semiconductor Co., Ltd.				
hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; NOW THIS WITNESSETH, that for and in consideration of One Dollár (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, in as ample and beneficial a manner as the said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assigner might or could have held and enjoyed the same, if this assignment had not been made.				
AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof. AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith. AND Assignors hereby grant the following individuals the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document: Rabin & Berdo, PC				
All practitioners at Customer Number 23995. AND Assignors acknowledge an obligation of assignment of this invention to Assignee at the time the invention was made.				
EXECUTED, March 28, 2013				

ASSIGNOR:

Kengo TAKEMASA

Rabin & Berdo, PC

WITNESS:

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT Page 2 of 2

	EXECUTED, Apr 1.	2013	,
WITNESS:		ASSIGNOR:	
Signature: _	Kergo Takemeisa		Yuichi YOSHIDA
	EXECUTED, April 1,	2013	
WITNESS:		ASSIGNOR:	
Signature: _	Sitom Sito		Joshihisa Sone Toshihisa SONE
	EXECUTED,April	1, 2013	·
WITNESS:		ASSIGNOR:	
Signature: _	Latorn Sato		Hagurja Yamada Kazuya YAMADA
	EXECUTED, April	1. 2013	·
WITNESS:		ASSIGNOR:	
Signature: _	nobuhiro Tomari		
		ivame:	Akihiro TAKEI

Rabin & Berdo, PC

RECORDED: 01/04/2016

PATENT REEL: 037401 FRAME: 0296